

HSF

SPECIFICATIONS

Rated Current:3AMP

Contact Resistance:50mΩ Max

Withstand Voltage:1000VAC for 1 minute

Insulation Resistance:1000MΩ Min

Operation Temperature:-20℃ to +85℃

Mating force:1.96N Max

Un-mating force:0.49N Min

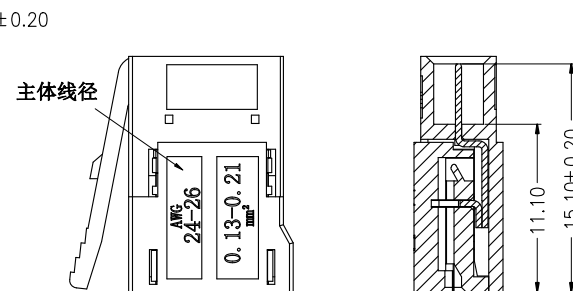
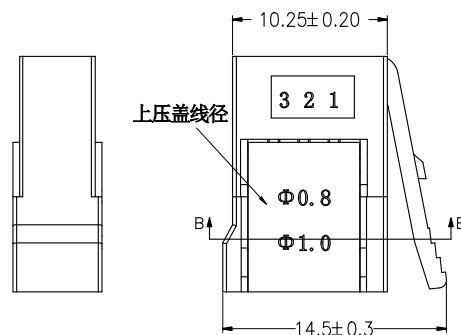
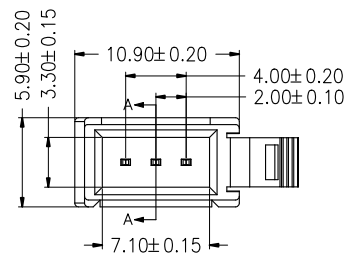
Contact Material:Copper Alloy

Contact Plating:Au Over Ni

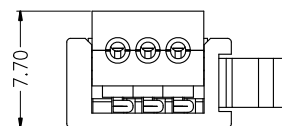
Housing Materials: PBT UL94V-0

Bottom Cover Materials: PC UL94V-0

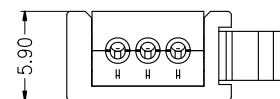
Top Cover Materials: PC UL94V-0



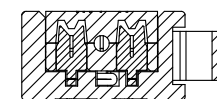
A-A SECTION



打开状态



压合状态



B-B SECTION

主体颜色	上压盖颜色	上压盖线径	主体线径
黑色	紫色	φ0.6-0.8	AWG24-26 0.13-0.21MM²
	红色	φ0.8-1.0	
	橙色	φ1.2-1.6	
	绿色	φ1.0-1.2	AWG20-22 0.3-0.50MM²
	黄色	φ1.2-1.6	
	蓝色	φ1.2-1.6	
	灰色	φ1.6-2.0	

				OPERATION		DRAW	OUYANG	22.03.02	SCALE	FIT	JILN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK			SIZE	A4		
				X.XXX	±0.10				SHEET	1/1		
A0	2022.03.02	NEW DRAWING		Angle	±3°	APPROVE			PROJ.	1/1	PART NO. 8310-M03G1AX0X	
REV	DATE	MODIFICATION DESCRIPTION		DIM	TOL						TITLE: 三芯公座	